



RoHS Compliant



Features -

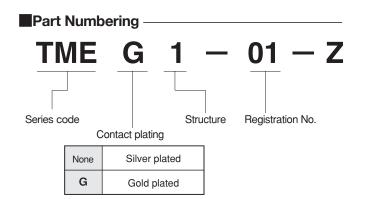
- 1. Compatible With Lead-Free Soldering
 Heat-resistance resin for lead-free soldering.
- 2. Washable
- 3. 2.54 mm Terminal Pins
- 4. Compatible with Automatic IC Insertion Machine (Stick packaging, 50 pcs/stick)
- 5. 180° Symmetric Terminal Pin Layout.
- 6. Anti-Static Electricity

Ground terminal is provided to prevent damage to element caused by static electricity.

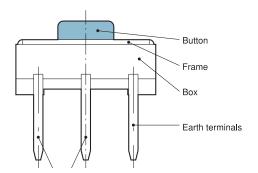
7. Metal contact for sharp tactile feel.

■ Specifications -

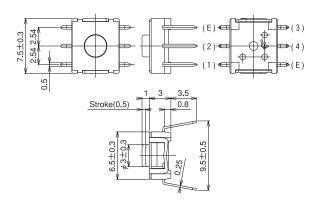
Contact plating		Silver plated Gold plated		
Rating	Max.	1VA max. (50mA max.48VDC max.)		
Initial contact resistance		100m Ω max. {1.5mA 200μVAC at 1.96N{200gf} force}		
Dielectric strength		250VAC 1 minute		
Insulation resistance		100MΩ min. (100VD0		
Electrical life		1,000,000 operations		
Stroke		0.5 ± 0.3mm		
Operating force		1.96±0.98N		
Operating temperature range		−25~+70°C		
Storage temperature range		-40~+70°C		



Structure



SPST -



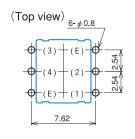
■ Table of Part Numbers

Contact plating	Part No.
Silver plated	TME1-01-Z
Gold plated	TMEG1-01-Z

	Switching function		
Part No.	_	Push	Circuit diagrams
TME1-01-Z TMEG1-01-Z	OFF	(ON)	(1) (E)
Connecting terminals		(2)(1) (3)(4)	(E) (3)

(ON): Momentary

■PC Hole Layouts



•Terminal (E) to be connected to Ground. Terminal (E) is connected to the metal frame.

The blue line shows the outline of the switch.

■ Soldering Specifications

(1)Manual Soldering

Device: Soldering iron

 380° C $\pm 10^{\circ}$ C; 3 ± 0.5 seconds

(2)Auto Soldering

Device: Jet wave type or dip type

275°C; 6 seconds, Max.

- Preheating should be at 80°C to 120°C, max., within 120 seconds.
- (3)When soldering two or more terminals to the common land, use solder resist to solder them independently.

Flux Cleaning ·····See page 225.

■Packaging Specifications -

